

## **Description**

The CWDM3011P uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

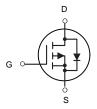


#### SOP-8

### **General Features**

 $V_{DS} = -30 V I_{D} = -11 A$ 

 $R_{DS(ON)}$  < 16m $\Omega$  @  $V_{GS}$ =10V



#### P-Channel MOSFET

## **Application**

Battery protection

Load switch

Uninterruptible power supply

# **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
CWDM3011P	SOP-8	HXY MOSFET	3000

# Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	- 30	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>A</sub> =25°C	Drain Current <sup>3</sup> , V <sub>GS</sub> @ 10V	-11	Α
IDM	Pulsed Drain Current <sup>1</sup>	-40	А
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	3.7	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction-ambient <sup>3</sup>	33.8	°C/W



# Electrical Characteristics (T<sub>J</sub> =25°C, unless otherwise noted)

Symbol	Parameter	<b>Test Condition</b>	Min.	Тур.	Max.	Units
Off Charac	Off Characteristic					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	-30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -30V, V <sub>GS</sub> =0V,	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
On Charac	n Characteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=-250\mu A$	-1.0	-1.6	-2.5	V
	Static Drain-Source on-Resistance	V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A	-	13	16	
$R_{DS(on)}$		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A	-	18	27	mΩ
Dynamic (	Characteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15V, V <sub>GS</sub> =0V, f=1.0MHz	-	1330	-	pF
Coss	Output Capacitance		-	183	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1-1.0IVII 12	-	156	-	pF
Qg	Total Gate Charge	V <sub>DS</sub> = -15V, I <sub>D</sub> = -5A, V <sub>GS</sub> = -10V	-	22	-	nC
Qgs	Gate-Source Charge		-	1.0	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge	VGS= -10 V	-	1.8	-	nC
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-on Delay Time		-	9	-	ns
t <sub>r</sub>	Turn-on Rise Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -10A,	-	13	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time	$V_{GS}$ =-10V, $R_{GEN}$ =2.5 $\Omega$	-	48	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	20	-	ns
Drain-Sou	rce Diode Characteristics and Maximu	um Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	-11	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-40	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -15A	-	-0.8	-1.2	V
trr	Reverse Recovery Time	TJ=25°C,	-	64	ı	ns
Qrr	Reverse Recovery Charge	$V_{DD}$ = -24V,I <sub>F</sub> =-2.8A, dI/dt=-100A/ $\mu$ s	-	25	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition:  $T_J$ =25°C,  $V_{GS}$ =10V,  $R_G$ =25 $\Omega$ , L=0.5mH,  $I_{AS}$ =-12.7A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



## **Typical Characteristics**

Figure1: Output Characteristics

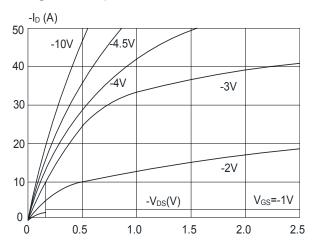


Figure 3:On-resistance vs. Drain Current

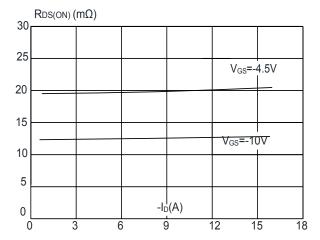


Figure 5: Gate Charge Characteristics

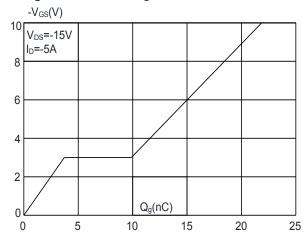


Figure 2: Typical Transfer Characteristics

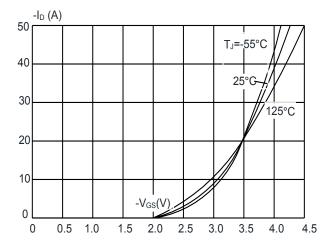


Figure 4: Body Diode Characteristics

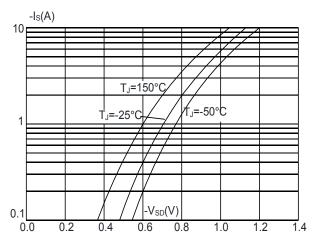
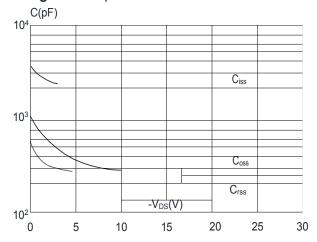


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

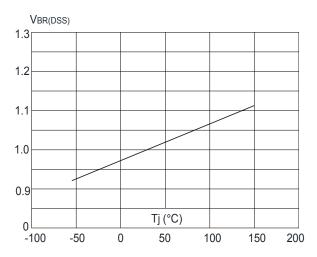
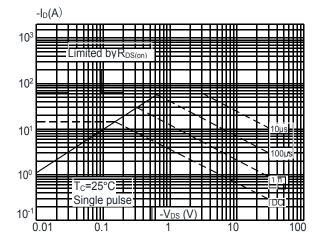
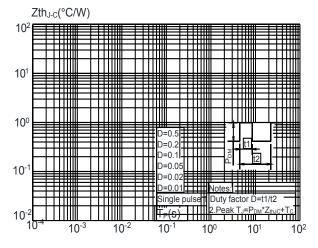


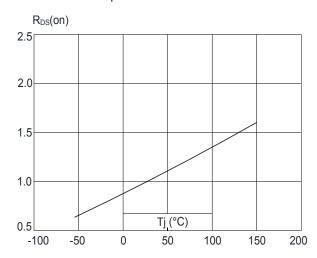
Figure 9: Maximum Safe Operating Area



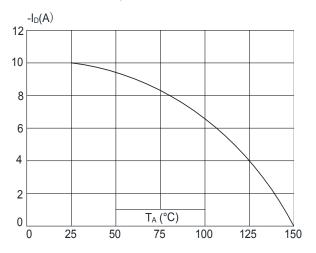
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case

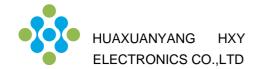


**Figure 8:** Normalized on Resistance vs. Junction Temperature



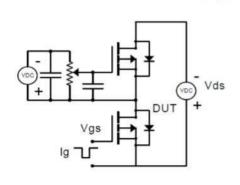
**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature

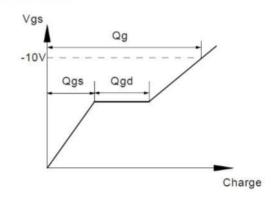




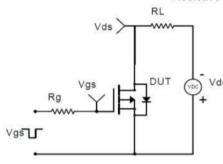
#### **Test Circuit**

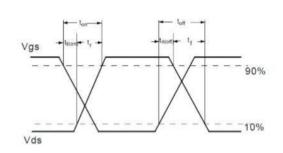
### Gate Charge Test Circuit & Waveform



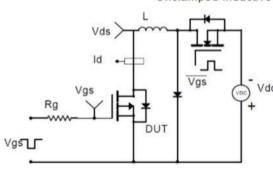


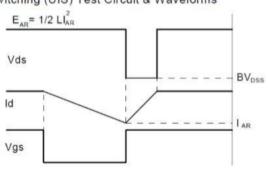
#### Resistive Switching Test Circuit & Waveforms



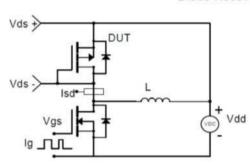


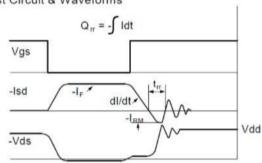
### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





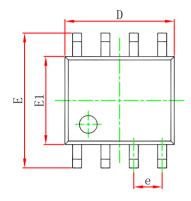
### Diode Recovery Test Circuit & Waveforms

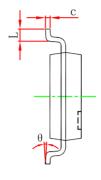


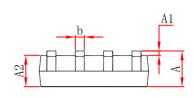




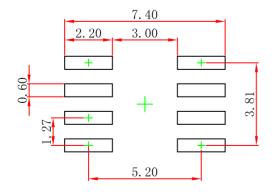
# **SOP-8 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	1. 350	1.750	0.053	0.069	
A1	0.100	0. 250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
c	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0. 197	
e	1.270 (BSC)		0.050 (BSC)		
Е	5.800	6. 200	0.228	0. 244	
E1	3.800	4.000	0.150	0. 157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



#### Note:

- 1. Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

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